

## **GS2986 Multi-Rate SDI Reclocker with Equalization & De-emphasis**

#### Features

- SMPTE 424M, SMPTE 292M and SMPTE 259M-C compliant
- Supports DVB-ASI at 270Mb/s
- Single supply operation at 3.3V or 2.5V
- 180mW typical power consumption (213mW with RCO enabled) at 2.5V
- Input signal equalization and output-signal de-emphasis settings to compensate for board-trace dielectric losses
- 4:1 input multiplexer patented technology
- Choice of dual reclocked data outputs or one reclocked data
  output and one clock output
- Uses standard 27MHz crystal
- Cascadable crystal buffer supports multiple reclockers using a single crystal
- Differential inputs and outputs
  - support DC coupling to industry-standard differential logic
  - on-chip  $100\Omega$  differential data input/output termination
  - selectable 400mVppd or 800mVppd output swing on each output
  - seamless interface to other Gennum products
- 4 wire SPI host interface for device configuration and monitoring
- Standard logic control and status signal levels
- Auto and Manual modes for rate selection
- Standards indication in Auto mode
- Lock Detect Output
- Mute, Bypass and Autobypass functions
- SD/HD indication output to control GS2978 or GS2988 dual slew-rate cable drivers
- Operating temperature range: -40°C to +85°C
- Small footprint QFN package (6mm x 6mm)
- Pb-free and RoHS compliant

### Applications

• SMPTE 424M, SMPTE 292M and SMPTE 259M-C coaxial cable serial digital interfaces

### Description

The GS2986 is a multi-rate serial digital reclocker designed to automatically recover the embedded clock from a digital video signal and retime the incoming video data. It will recover the embedded clock signal and retime the data from a SMPTE 424M, SMPTE 292M, or SMPTE 259M-C compliant digital video signal.

A serial host interface provides the ability to configure and monitor multiple GS2986 devices in a daisy-chain configuration.

Adjustable input trace equalization (EQ) for up to 40" of FR4 trace losses, and adjustable output de-emphasis (DE) for up to 20" of FR4 trace losses, can be configured via the host interface.

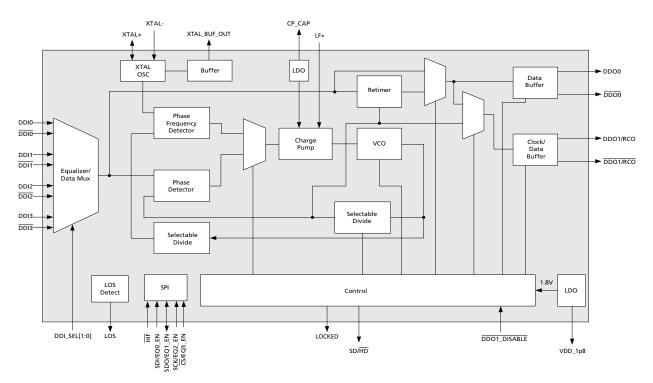
The GS2986 can operate in either auto or manual rate selection mode. In Auto mode, the device will automatically detect and lock onto incoming SMPTE SDI data signals at any supported rate. For single rate data systems, the GS2986 can be configured to operate in Manual mode. In both modes, the device requires only one external crystal to set the VCO frequency when not locked and provides adjustment free operation.

The GS2986 accepts industry-standard differential input levels including LVPECL and CML. The differential data and clock outputs feature selectable output swing via the host interface, ensuring compatibility with most industry-standard, terminated differential receivers.

The GS2986 features dual differential outputs. The second output can be configured to emit either the recovered clock signal or the re-timed video data. This output can also be disabled to save power.

In systems which require passing of non-SMPTE data rates, the GS2986 can be configured to either automatically or manually enter a bypass mode in order to pass the signal without reclocking.

The GS2986 is Pb-free, and the encapsulation compound does not contain halogenated flame retardant. This component and all homogeneous sub-components are RoHS compliant.





### **Revision History**

Version	ECR	PCN	Date	Changes and/or Modifications
3	158335	_	July 2012	Removed jumper from Figure 5-1: GS2986 Typical Application Circuit
2	158129	-	May 2012	Corrected 4.15.3 section to make it easier to follow and changed to Semtech template.
1	153705	_	March 2010	Converted to Data Sheet. Updated Power numbers in Table 2-1: DC Electrical Characteristics. Added Table 4-5: Suggested LOS Threshold Settings.
0	152591	_	September 2009	Converted to Preliminary Data Sheet. Updates to Electrical Characteristics. Updates to Section 4.15 Host Interface.
В	151972	-	July 2009	Added Section 4.15 Host Interface. Updated Power numbers in Table 2-1: DC Electrical Characteristics and Loop Bandwidth numbers in Table 2-2: AC Electrical Characteristics. Added Table 1-2: GS2986 Default Start-up Settings and Figure 4-2: De-emphasis Waveform.
А	151668	_	April 2009	New document.



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# 1. Pin Out

### **1.1 Pin Assignment**

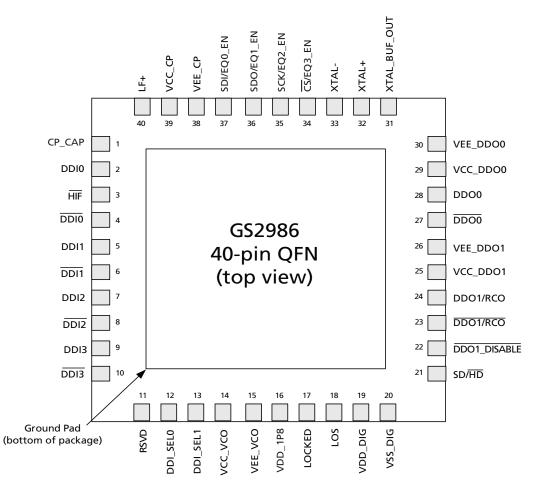


Figure 1-1: GS2986 Pin Out



## **1.2 Pin Descriptions**

#### Table 1-1: GS2986 Pin Descriptions

in Number Name		Туре	Description
1	CP_CAP	Power	External capacitor for internal LDO regulator supplying the charge pump circuit.
2, 4	DDI0, <u>DDI0</u>	Input	Serial Digital Differential Input 0.
3	HIF	Logic Input	Host interface selection pin. Active-low input. See Section 4.15.1.
5, 6	DDI1, DDI1	Input	Serial Digital Differential Input 1.
7, 8	DDI2, DDI2	Input	Serial Digital Differential Input 2.
9, 10	DDI3, DDI3	Input	Serial Digital Differential Input 3.
11	RSVD	Reserved	Reserved pin. Do not connect to this pin.
12, 13	DDI_SEL[0:1]	Logic Input	Selects one of four serial digital input signals for processing. See Section 4.4.
14	VCC_VCO	Power	Most positive power supply connection for the internal VCO section. Connect to a 3.3V supply with a 422 $\Omega$ resistor, or to a 2.5V supply with a 267 $\Omega$ resistor.
15	VEE_VCO	Power	Most negative power supply connection for the internal VCO section. Connect to GND.
16	VDD_1P8	Power	External capacitor for internal 1.8V digital supply.
17	LOCKED	Output	Lock Detect status signal. HIGH when the PLL is locked.
18	LOS	Output	Loss Of Signal status. HIGH when the input signal is invalid.
19	VDD_DIG	Power	Most positive power supply connection for the digital core. Connect to 3.3V or 2.5V.
20	VSS_DIG	Power	Most negative power supply for the digital core. Connect to GND.
21	SD/HD	Output	This signal will be LOW for all rates other than 270Mb/s. This signal is HIGH for 270Mb/s.
22	DDO1_DISABLE	Logic Input	Disables the DDO1/RCO and DDO1/RCO outputs when LOW. See Section 4.14.
23, 24	DDO1/RCO, DDO1/RCO	Output	Differential serial clock or data outputs.
25	VCC_DDO1	Power	Most positive power supply connection for the DDO1/DDO1 output drive Connect to 3.3V or 2.5V.
26	VEE_DDO1	Power	Most negative power supply connection for the DDO1/DDO1 output driver. Connect to GND.
27, 28	DD00, DD00	Output	Differential Serial Digital Outputs.



Pin Number	Name	Туре	Description
29	VCC_DDO0	Power	Most positive power supply connection for the DDO0/DDO0 output driver. Connect to 3.3V or 2.5V.
30	VEE_DDO0	Power	Most negative power supply connection for the DDO0/DDO0 output driver.
			Connect to GND.
31	XTAL_BUF_OUT	Output	Buffered output of the reference oscillator.
32	XTAL+	Output	Reference crystal output.
33	XTAL-	Input	Reference crystal input.
34	CS/EQ3_EN	Input/Logic Input	In host mode (HIF set LOW): Chip select input for SPI serial host interface. Active-low input. In non-host mode (HIF set HIGH): Trace equalization on/off pin for Serial Digital Differential Input 3. Active-high input.
35	SCK/EQ2_EN	Input/Logic Input	In host mode (HIF set LOW): Burst-mode clock input for SPI serial host interface. In non-host mode (HIF set HIGH): Trace equalization on/off pin for Serial Digital Differential Input 2. Active-high input.
36	SDO/EQ1_EN	Input/Logic Input	In host mode (HIF set LOW): Serial digital data output for SPI serial host interface. Active-high output. In non-host mode (HIF set HIGH): Trace equalization on/off pin for Serial Digital Differential Input 1. Active-high input.
37	SDI/EQ0_EN	Input/Logic Input	In host mode (HIF set LOW): Serial digital data input for SPI serial host interface. Active-high input. In non-host mode (HIF set HIGH): Trace equalization on/off pin for Serial Digital Differential Input 0. Active-high input.
38	VEE_CP	Power	Most negative power supply connection for the internal charge pump. Connect to GND.
39	VCC_CP	Power	Most positive power supply connection for the internal charge pump. Connect to 3.3V or 2.5V
40	LF+	Passive	Loop Filter capacitor connection. (CLF = 47nF). Connect as shown in Typica Application Circuit on page 37.
_	Center Pad	_	Ground pad on bottom of package. Connect to GND.

## **1.3 Default Start-up Settings**

The GS2986 has some functions that are not accessible via direct pin control, and are only accessible through the host interface registers. These functions have an internal pull-up or pull-down resistor that sets the default logic level or start-up state, if it is not already set by a pin.

If the user wishes to override these logic levels, the associated bit should be programmed within the PIN\_OR\_1 register (pin override register) at address 0x0C. The logic values within the PIN\_OR\_1 register become active when the user sets the Pin Override Enable bit to HIGH within that same register.

#### Table 1-2 shows:

- 1. The default logic state set by the internal pull-up or pull-down resistors.
- 2. The default values within the Pin Override register upon reset.

More details are given in Section 4.15.

Name	Description	Default State set by Internal Resistors	Default State within the Pin Override Register		
BYPASS	Bypasses the reclocker stage when set HIGH.	0	0		
AUTOBYPASS	When set HIGH, this bit automatically bypasses the reclocker stage when the PLL is not locked to a supported rate.	0	0		
AUTO/MAN	When set HIGH, the standard is automatically detected from the input data rate.	ard is automatically detected 1			
SS0, SS1	When AUTO/MAN is set HIGH, SS[1:0] are outputs displaying the data rate to which the PLL has locked. Therefore, the bits will not have a default start-up value.	None	0:0		
KBB	Controls the loop bandwidth of the PLL.	Floating	Ground		
DATA_MUTE	Mutes the DDO0/DDO0 and DDO1/DDO1 (if data is selected) outputs when LOW.	1	0		
DATA/CLOCK	HIGH = DATA LOW = CLOCK	0	0		
DE_EN	De-emphasis on/off pin for serial digital output. HIGH = de-emphasis on LOW = de-emphasis off	0	0		

#### Table 1-2: GS2986 Default Start-up Settings



# 2. Electrical Characteristics

### 2.1 Absolute Maximum Ratings

Parameter	Value		
Supply Voltage	-0.5 to +3.6V <sub>DC</sub>		
Input ESD Voltage	4kV		
Storage Temperature Range	-50°C < T <sub>A</sub> < 125°C		
Operating Temperature Range	-40°C to 85°C		
Input Voltage Range	-0.3 to (VCC + 0.3) V <sub>DC</sub>		
Solder Reflow Temperature	260°C		

## **2.2 DC Electrical Characteristics**

#### **Table 2-1: DC Electrical Characteristics**

Parameter	Symbol	Conditions	Min	Тур	Мах	Units
Supply Voltage	VDD	3.3V	3.135	3.3	3.465	V
		2.5V	2.375	2.5	2.625	V
Power (DDO1/RCO disabled, minimum	Р	VDD = 3.3V	_	250	325	mW
output swing)		VDD = 2.5V	-	180	235	mW
Power (DDO1/RCO enabled, minimum	_	VDD = 3.3V	-	290	390	mW
output swing)		VDD = 2.5V	-	210	275	mW
Power in Power-down mode	_	VDD = 3.3V	-	48	60	mW
		VDD = 2.5V	_	30	40	mW
Serial Input Termination	-	Differential	80	100	120	Ω
Serial Output Termination	_	Differential	80	100	120	Ω
Serial Input Common Mode Voltage	_	-	1.6	_	VDD	V
Serial Output Common Mode Voltage	-	_	_	VCC- (∆VOD /2)	-	V
VIL (2.5V operation)	_	VOUT≤VOL, max	-0.3	-	0.7	V
VIL (3.3V operation)	_	VOUT≤VOL, max	-0.3	-	0.8	V
VIH (2.5V operation)	-	VOUT≥VOH, min	1.7	-	VDD +0.3	V
VIH (3.3V operation)	_	VOUT≥VOH, min	2	_	VDD +0.3	V
lin	_	VIN = 0V or VIN = VDD	_	+/-10	+/-20	μA



#### Table 2-1: DC Electrical Characteristics (Continued)

Parameter	Symbol	Conditions	Min	Тур	Max	Units
VOL (2.5V operation)	_	VDD = min, IOL = 100µA	_	-	0.2	V
VOL (3.3V operation)		VDD = min, IOL = 100µA	_	-	0.2	V
VOH (2.5V operation)	-	VDD = min, IOH = -100µA	2.1	_	_	V
VOH (3.3V operation)		VDD = min, IOH = -100µA	VDD -0.4	-	_	V
Hysteresis Voltage (SPI inputs)	_	2.5V operation	_	350	_	mV
NOTE: guaranteed by simulation.		3.3V operation	_	350	-	mV

## 2.3 AC Electrical Characteristics

#### **Table 2-2: AC Electrical Characteristics**

Parameter	Symbol	Conditions	Min	Тур	Мах	Units	Notes
Serial Input Data Rate (for reclocking)	DR <sub>SDO</sub>	-	0.27	-	2.97	Gb/s	-
Serial Input Data Rate (bypass)		-	DC	_	2.97	Gb/s	-
SPI Operating Speed	_	_	_	_	10	MHz	_
Input Voltage Swing	∆VSDI	Set ATTEN_EN = 1 for ∆VSDI>1V <sub>pp</sub>	100	_	2000	mV <sub>p-pd</sub>	_
Output Voltage Swing	ΔVOD	default	300	400	500	mV <sub>p-pd</sub>	-
		see DRIVER_1 register (0x01) addresses 8 & 9 in 4.15.14 Host Register Map.	600	800	1000	mV <sub>p-pd</sub>	_
Input Trace Equalization	-	LOW	Recom		setting foi s of FR4	0 to 10	-
		MED	Recom		etting for s of FR4	10 to 20	-
		HIGH	Recomm		tting for > FR4	20 inches	-



Parameter	Symbol	Conditions	Min	Тур	Мах	Units	Notes
Output De-Emphasis	-	OFF - 0	-	0	-	dB	-
		ON - 0	-	0	_	dB	_
		ON - 1	-	0.7	_	dB	_
		ON - 2	_	1.3	_	dB	_
		ON - 3	_	2	_	dB	_
		ON - 4	-	2.6	_	dB	_
		ON - 5	-	3.3	_	dB	_
		ON - 6	-	4	_	dB	_
		ON - 7	_	4.7	_	dB	_
Input Jitter Tolerance	_	square-wave modulated jitter	0.8	_	_	UI	_
Loop Bandwidth	BW <sub>LOOP</sub>	KBB = VCC	_	170	_	kHz	_
	(270Mb/s)	KBB = FLOAT	-	340	-	kHz	_
		KBB = GND	-	680	-	kHz	_
	BW <sub>LOOP</sub> (1485Mb/s)	KBB = VCC	-	0.875	-	MHz	_
		KBB = FLOAT	_	1.75	_	MHz	_
		KBB = GND	-	3.5	_	MHz	_
	BWLOOP	KBB = VCC	-	1.75	_	MHz	_
	(2970Mb/s)	KBB = FLOAT	-	3.5	_	MHz	_
		KBB = GND	-	7.0	_	MHz	_
PLL Lock Time (asynchronous)	t <sub>alock</sub>	-	-	0.5	1	ms	_
PLL Lock Time (synchronous)	t <sub>slock</sub>	CLF = 47nF, SD/HD = 0	_	0.5	4	μs	_
		CLF = 47nF, SD/HD = 1	_	5	10	μs	_
Serial Data output Jitter Intrinsic (DDO0)	t <sub>OJ(270MB/s)</sub>	KBB = FLOAT PRN 2^23-1 test pattern	_	0.01	_	UI	-
	t <sub>OJ(1485MB/s)</sub>	KBB = FLOAT PRN 2^23-1 test pattern	-	0.03	-	UI	_
	t <sub>OJ(2970MB/s)</sub>	KBB = FLOAT PRN 2^23-1 test pattern	_	0.05	_	UI	_
Output Rise/Fall Time	tr/f	20% to 80% (400mV swing)	-	65	_	ps	_
		20% to 80% (800mV swing)	_	80	_	ps	_
Output Rise/Fall Time Mismatch	_	_	-	-	15	ps	-



Table 2-2: AC Electrical	Characteristics	(Continued)
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Parameter	Symbol	Conditions	Min	Тур	Мах	Units	Notes
Eye Cross Shift	_	percentage of signal amplitude	_	_	5	%	-
Power Supply Noise Rejection	_	50 - 100Hz	_	100	_	mV <sub>p-p</sub>	_
		100Hz - 10MHz	_	40	_	mV <sub>p-p</sub>	_
		10MHz - 1.485GHz	_	10	_	mV <sub>p-p</sub>	-



# **3. Input/Output Circuits**

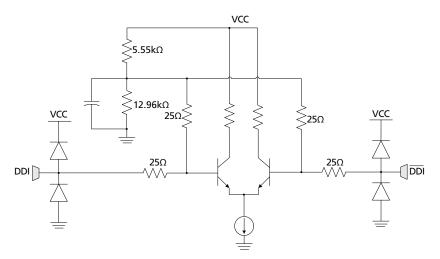


Figure 3-1: High-speed Inputs (DDI0, DDI0, DDI1, DDI1, DDI2, DDI2, DDI3, DDI3)

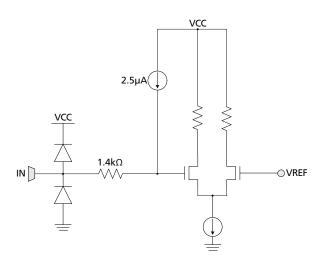


Figure 3-2: Low-speed Input with weak internal pull-up (HIF, DDO1\_DISABLE)



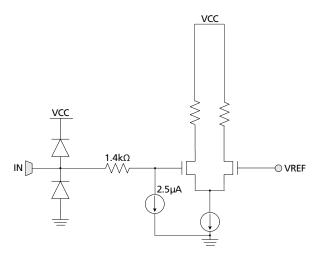


Figure 3-3: Low-speed Input with weak internal pull-down (DDI\_SEL0, DDI\_SEL1)

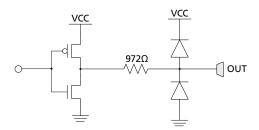


Figure 3-4: Low-speed Outputs (LOCKED, LOS, SD/HD)

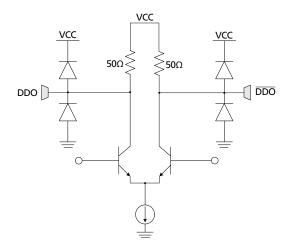


Figure 3-5: High-speed Outputs (DDO1/RCO, DDO1/RCO, DDO0)



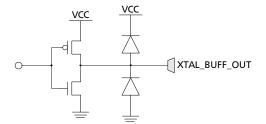


Figure 3-6: Crystal Buffered Output (XTAL\_BUF\_OUT)

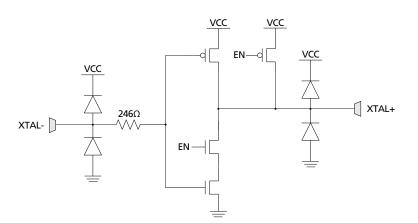


Figure 3-7: High-speed Crystal Oscillator I/O (XTAL-, XTAL+)

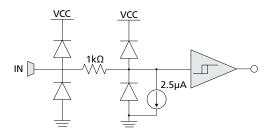


Figure 3-8: SPI Inputs/EQ Ctrl (CS/EQ3\_EN, SCK/EQ2\_EN, SDI/EQ0\_EN)



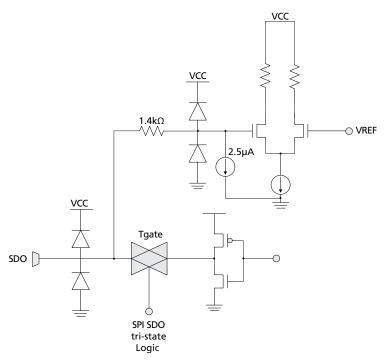


Figure 3-9: SPI Output/EQ Control (SDO/EQ1\_EN)



# 4. Detailed Description

The GS2986 is a multi-standard reclocker for serial digital SDTV signals operating at 270Mb/s, and HDTV signals operating at 1.485Gb/s, 1.485/1.001Gb/s, 2.97Gb/s and 2.97/1.001Gb/s.

## 4.1 Serial Data Input

The GS2986 features four differential input buffers.

The serial data input signal is connected to the DDI0/DDI0, DDI1/DDI1, DDI2/DDI2 and DDI3/DDI3 input pins of the device.

Input signals can be single-ended or differential, DC or AC-coupled.

The input circuit is self-biasing, to allow for simple AC or DC-coupling of input signals to the device.

## 4.2 Modes of Operation

The GS2986 has two modes of operation: Legacy Mode ( $\overline{\text{HIF}}$  = HIGH) and SPI Mode ( $\overline{\text{HIF}}$  = LOW).

In Legacy Mode, chip functions are controlled via pins only, and offers limited control of input Equalization.

In SPI mode, access is gained to extended digital controls like: Bypass, Autobypass, Auto/Manual selection, Control status inputs or outputs, changes to KBB settings, additional EQ and DE settings as well as access to additional features such as LOS adjustment, polarity invert, auto-mute, etc.

## 4.3 Input Trace Equalization

The GS2986 features adjustable trace equalization to compensate for PCB trace dielectric losses at 1.5GHz.

The trace equalization has three peak-gain settings. The maximum peak gain value is optimized for compensating the high-frequency losses associated with 25 inches of 5-mil stripline in FR4 material. For boards with different striplines or materials, users can experiment to find the EQ setting which optimizes their system performance.

These settings are accessible via the serial host interface.

Each serial digital input; DDI,  $\overline{\text{DDI}}$  includes a pin EQn\_EN to turn its trace equalizer on or off. When a pin EQn\_EN is tied LOW or left unconnected, the trace equalization for input n is set to LOW.

When an EQn\_EN pin is tied HIGH, and input n is selected, the trace equalization for input n is set to Medium.



#### Table 4-1: Input Trace Equalization Operation

EQn_EN Setting	Trace Equalization		
LOW	Low		
HIGH	Medium		

The default peak-gain setting upon power-up is optimized for compensating the high-frequency losses associated with approximately 10 inches of 5-mil stripline in FR4 material.

The EQn\_EN pins are multiplexed with the serial host interface pins when pin HIF is tied high, as shown in Table 4-2:

#### Table 4-2: EQn\_EN Pins Multiplexed

Pin	Function
SDI/EQ0_EN	Active-high logic input to enable trace-equalization for high-speed input channel 0.
SDO/EQ1_EN	Active-high logic input to enable trace-equalization for high-speed input channel 1.
SCK/EQ2_EN	Active-high logic input to enable trace-equalization for high-speed input channel 2.
CS/EQ3_EN	Active-high logic input to enable trace-equalization for high-speed input channel 3.

### 4.4 4:1 Input Mux

The GS2986 incorporates a 4:1 input mux, which allows the connection of four independent streams of video/data. There are four differential inputs ( $DDI[3:0]/\overline{DDI[3:0]}$ ). The active channel can be selected via the DDI\_SEL[1:0] pins as shown in Table 4-3.

#### Table 4-3: Input Selection Table

DDI_SEL[1:0]	Selected Input
00	DDI0
01	DDI1
10	DDI2
11	DDI3

The DDI\_SEL pins include internal pulldowns which pull the input voltage LOW if either pin is unconnected. Active circuitry associated with the input buffers and trace EQ can only be turned on for the selected input. Inputs which are not selected have their input buffers and trace EQs turned OFF to save power. Unused inputs can be either left floating, or tied to VCC.



## 4.5 Crystal Buffer

The GS2986 features a crystal buffer supporting a Gennum recommended external 27MHz crystal. The GS2986 requires an external 27MHz reference clock for correct operation. This reference clock is generated by connecting a crystal to the XTAL- and XTAL+ pins of the device.

Alternately, a 27MHz external clock source can be connected to the XTAL- pin of the device, while the XTAL+ pin should be left floating.

## 4.6 LOS (Loss Of Signal) Detection

The LOS (Loss Of Signal) status pin is an active-high output that indicates when the serial digital input signal selected at the 4:1 input mux is invalid. In order for this output to be asserted, transitions must not be present for a period of  $t_{LA} = 5 - 10\mu s$ . After this output has been asserted, LOS will de-assert within  $t_{LD} = 0 - 5\mu s$  after the appearance of a transition at the DDIx input. See Figure 4-1.

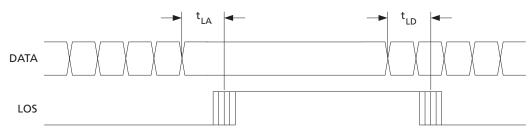
This signal is HIGH (signal lost), when the number of data edges within a window is below a defined threshold. The output is automatically muted when LOS is detected.

This signal is LOW (signal valid), when the number of data edges within a window is above a defined threshold. See Table 4-4.

#### Table 4-4: LOS Operation

LOS	Signal	
HIGH	Invalid	
LOW	Valid	

The LOS function is operational for all operating modes of the device.





The LOS detector has two major modes. In legacy mode, a simple edge-based detector is used to monitor the received signal at the output of the data slicer. Since the incoming signal has undergone considerable gain by this point, the legacy detector can be more susceptible to false de-assertion of LOS for unused channels which experience significant cross-talk from adjacent active channels.



The new LOS detector uses a measure of both signal amplitude and duration to minimize false detection of the impulse like signals that are characteristic of cross-talk. In this mode, the signal is tapped off at the output of the equalizer stage, prior to the high gain buffers.

The threshold setting within the detector can be adjusted to increase or decrease its sensitivity. Gennum recommends using the least sensitive threshold level. This provides the most margin against false de-assertion of LOS.

		LOS Detection Method Select	LOS Threshold Adjust
	>250mV	0x1	0x0
Input Signal	200mV to 250mV	0x1	0x1
Amplitude	150mV to 200mV	0x1	0x2
	<150mV	0x1 or 0x0	0x3

#### Table 4-5: Suggested LOS Threshold Settings

The LOS mode can be selected by using the host interface, in register TOP\_1 (address 0x02).

### 4.7 Serial Digital Reclocker

The output of the Equalizer is fed to the reclocker. The function of the reclocker is to re-time the input signal and to generate system clocks.

The reclocker operates at three frequencies; 2.97Gb/s, 1.485Gb/s and 270Mb/s, and provides a minimum input jitter tolerance of 0.8UI to square-wave-modulated jitter at these rates.

When there is no serial input signal, the internal clock maintains a frequency close to the expected incoming data rate by locking to the external reference crystal.

### 4.8 Lock Detection

The lock detect block indicates, via the active-high LOCKED signal, when the device has achieved lock to the incoming data stream.

The lock logic within the GS2986 includes a system that monitors the frequency and the phase of the incoming data, as well as a monitor to detect harmonic lock.

#### Table 4-6: Lock Operation

LOCKED	Status
HIGH	Locked
LOW	Not locked

The LOCKED output signal is also available via the host interface.

### 4.8.1 Lock Detect and Asynchronous Lock

The reference crystal is used to assist the PLL in achieving short lock time. The lock detection algorithm is a continuous process, which begins at device power up or after a system reset, and continues until the device is powered down.

The asynchronous lock time is defined as the time it takes the device to lock when a video signal is first applied to the serial digital inputs, or when the digital video signal rate changes.

The synchronous lock time is defined as the time it takes the device to lock to a signal which has been momentarily interrupted.

## 4.9 Serial Data Output

The GS2986 features two current-mode differential output drivers, each capable of driving a maximum of  $800 \text{mV}_{\text{pp}}$ , differential, into an external  $100\Omega$  differential load.

Each of the GS2986's output buffers include two on-chip,  $50\Omega$  termination resistors.

### 4.9.1 Output Signal Interface Levels

The serial digital outputs of the GS2986 are compatible when DC-coupled with all Gennum serial digital interface products that feature a differential LVPECL or CML receiver designed for SDI applications and operate from 3.3V or 2.5V supplies. This includes but is not limited to: GS2978, GS2988, and GS2989.

The serial digital data inputs are also compatible when DC-coupled with LVPECL or CML differential outputs from crosspoint switches which operate from 3.3V or 2.5V supplies. This includes but is not limited to: GS2974A, GS2974B, and GS2984 equalizers.

### 4.9.2 Adjustable Output Swing

It is possible, via the host interface, to force the output swing to  $400 mV_{pp}$  or  $800 mV_{pp}$  differential, when the outputs are terminated with  $50\Omega$  loads.

The default output swing upon power-up is  $400 \text{mV}_{pp}$  differential.

### 4.9.3 Output De-emphasis

The GS2986 features adjustable output de-emphasis to compensate for PCB trace dielectric losses.

The output de-emphasis has eight settings, evenly distributed from a minimum of 0dB (output de-emphasis OFF) to a peak de-emphasis setting that is optimized for compensating the high-frequency losses associated with approximately 20 inches of 5-mil stripline in FR4 material. These settings are accessible via the serial host interface.

The action of the de-emphasis settings is to attenuate the trailing edge of the output data waveform relative to the output swings set through the host interface.

De-emphasis is turned OFF when in Bypass mode.

The default de-emphasis setting upon power-up is 0dB (OFF).

NOTE: Changing the de-emphasis setting will vary both V1 & V2 (see Figure 4-2).



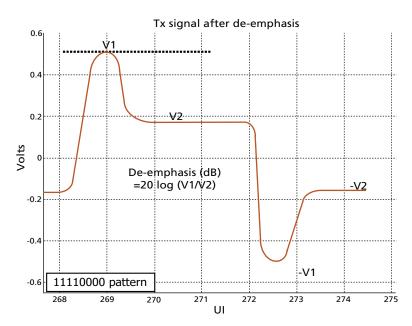


Figure 4-2: De-emphasis Waveform

## 4.10 Automatic and Manual Data Rate Selection

The GS2986 can be configured to manually lock to a specific data rate or automatically search for and lock to the incoming data rate. The default configuration is AUTO mode. This can be changed via the host interface.

In AUTO mode, the SS[1:0] registers become read only, and the bit pattern indicates the data rate at which the PLL is currently locked to (or previously locked to). The search algorithm cycles through the data rates and starts over if that data rate is not found (see Figure 4-3).

A "search algorithm" cycles through the supported data rates until lock is achieved, as shown in Figure 4-3 below.

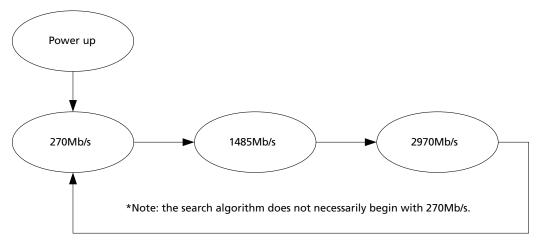


Figure 4-3: GS2986 Automatic Mode Search Algorithm

In MANUAL mode, the SS[1:0] registers become read or write pins become inputs and the data rate can be programmed. In this mode, the search algorithm is disabled and the GS2986's PLL



will only lock to the data rate selected in accordance with Table 4-7.

SS[1:0]	Data Rate (Mb/s)		
0	Reserved		
1	270		
2	1485 or 1485/1.001		
3	2970 or 2970/1.001		

Table 4-7: Data Rate Indication/Selection Bit Pattern

## 4.11 SD/HD Indication

The SD/HD signal indicates the output data rate of the device and can be connected to the SD/HD input pin of dual slew rate cable drivers such as the GS2988.

When this signal is HIGH, the data rate is 270Mb/s. This signal is LOW for all other data rates.

This signal is also LOW when the device is operating in bypass mode (Auto-bypass and User-bypass).

The SD/HD signal is LOW when the device is not locked.

### 4.12 Bypass Mode

In bypass mode, the GS2986 passes the data at the inputs, directly to the output. There are two register bits that control the bypass function: BYPASS and AUTOBYPASS.

The BYPASS bit is an active-high signal which forces the GS2986 into bypass mode for as long as the bit is asserted HIGH.

The AUTOBYPASS bit is an active-high signal that places the GS2986 into bypass mode only when the PLL has not locked to a data rate.

Bypass	Autobypass	Device Operation
HIGH	Х	Bypass Mode
LOW	HIGH	Bypass Mode if the PLL has not locked to a data rate
LOW	LOW	Power-up default. Normal Operation, part always tries to lock to the incoming data stream.

#### Table 4-8: Bypass Modes

Note that if BYPASS is HIGH, this will override the AUTOBYPASS functionality.

When the GS2986's PLL is not locked and BYPASS = LOW and AUTOBYPASS = LOW, the serial digital output DDO/DDO will produce invalid data.

The AUTOBYPASS function will bypass unsupported (non-reclocked) SMPTE SDI signal rates without producing bit errors: 143Mb/s, 177Mb/s, 360Mb/s, 540Mb/s.

### 4.13 DVB-ASI

The GS2986 also reclocks DVB-ASI signals at 270Mb/s. In auto mode, the device will automatically lock to the incoming 270Mb/s signal. In manual mode, the SS[1:0] pins must be set to 01 (270Mb/s) to ensure proper operation.

## 4.14 Output Mute and Data/Clock Output Selection

The DATA\_MUTE register is provided to allow muting of the serial digital data output.

Setting  $\overline{DATA}$ \_MUTE = LOW will force the serial digital outputs DDO/ $\overline{DDO}$  to mute (statically latch HIGH) under all conditions and operating modes.

The DDO1\_DISABLE pin is provided to allow the second data/clock output to be powered down.

When DDO1\_DISABLE is set LOW, the serial digital clock outputs DDO1/RCO and DDO1/RCO are muted and the driver is powered-down.

The DATA/CLOCK register is provided to allow the second output to emit a copy of the reclocked serial data or the recovered clock. In Legacy mode, the default is DATA output.

DATA_MUTE	DDO1_DISABLE	DATA/CLOCK	DDO0	DDO1/RCO
1	1	0	DATA	CLOCK
1	1	1	DATA	DATA
0	1	0	MUTE	CLOCK
0	1	1	MUTE	MUTE
1	0	х	DATA	Power down
0	0	х	MUTE	Power down

#### Table 4-9: Configuration of GS2986 Output Drivers and Mute/Disable Pins

### 4.15 Host Interface

### 4.15.1 Introduction

The GS2986 offers a Serial Peripheral Interface (SPI) to access advanced features and programmability. The polarity of the  $\overline{\text{HIF}}$  pin tells the GS2986 whether or not the host interface is active ( $\overline{\text{HIF}} = 0$ ) or in legacy mode ( $\overline{\text{HIF}} = 1$ ).

Using the host interface, it is possible to override the control pin settings, and such settings will persist until the device has been powered-down and/or reset. The host interface is capable of



reading hard-wired pin configuration, pin override settings and the values of all status monitoring pins.

There is an optional 3-state feature available in the Control Status Registers (CSR) that puts the SPI SDO to high-impedance when it's not being used (Register: TOP\_1, bit: 2).

The maximum operating speed of the SPI is 10MHz.

### 4.15.2 Legacy Mode & Start-up

In legacy mode, basic configuration of the device including a subset of equalizer settings are available at the pin level. In this mode, register settings are automatically set to default so that the IC is live at power-up.

### 4.15.3 Host Interface Mode & Start-up

In host interface mode, the user gains access to Control and Status Registers (CSRs) that manage advanced features. In this mode, equalizer and de-emphasis settings are set through the CSR.

The SPI control port is functional at start-up without the need for a separate, external reset signal. However, all internal registers must be set to their default state by issuing a required Reset Command via the SPI.

This is done by setting the  $\overline{R}$  bit (reset) LOW in the command word. This will guarantee the CSR will not start up in a random state.

A simple way to issue the required reset of the CSR is to hold the slave device's SDI input LOW for an entire 64 cycle WRITE communication. Details of the WRITE operation are found in section 4.15.6 below.

### 4.15.4 Clock & Data Timing

The SPI signals are Serial Data Input (SDI), Serial Data Output (SDO), active-low Chip Select ( $\overline{\text{CS}}$ ), and Serial Clock Input (SCK). The host interface operates in SPI Mode 0, i.e. the SDI input will latch data in on the rising edge of SCK. The SDO data output will transition on falling edges of SCK. Data is transmitted or received on the SPI port MSB first LSB last.

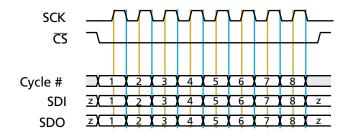


Figure 4-4: Data Clock Alignment



### 4.15.5 Single Device Operation

For applications with a single device or applications with multiple devices where daisy chaining is not desired, the chain position bits C[6:0] should always be set to 0. As a by-product of the daisy chaining feature, Read and Write operations experience a 32 SCK cycle latency from SDI to SDO. For more details on daisy-chaining, refer to Section 4.15.8 on page 29.

rw	0	0	R	A[4:0]	C <sub>N</sub> [6:0] = `0000000'
Reac Writ		F	Reset	Address	Chain Position

Figure 4-5: 16-bit Command Format

### 4.15.6 Write Operation - Single Device

A Write operation consists of a 16-bit command word and a 16-bit data word, followed by 32 cycles with the slave SDI held HIGH. When writing to a single non-daisy chained device, the following format should be used:

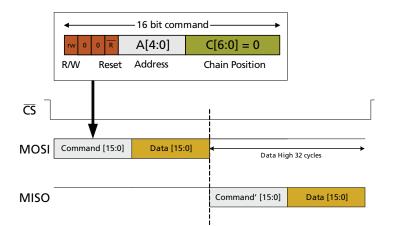


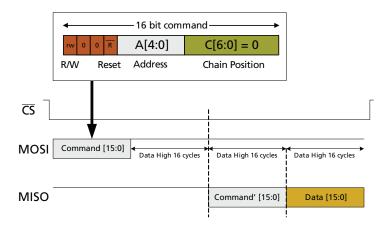
Figure 4-6: Single Device Write

- 1. At power-up, the device should be reset by setting the  $\overline{R}$  bit LOW. A simple way to accomplish a reset is to hold the slave SDI line low for an entire 64 cycle communication.
- 2. For a Write operation, the r/w bit should be set to 0.
- 3. The 2nd and 3rd bits are reserved and should be set to 0.
- 4. The  $\overline{R}$  bit should always be set HIGH for a normal Write operation.
- 5. Refer to the Register Map for information on Address and Data bits.
- 6. The slave SDI line should be held HIGH for 32 cycles before de-asserting  $\overline{CS}$ .



### 4.15.7 Read Operation - Single Device

For Reading from a device the following format should be used:



#### Figure 4-7: Single Device Read

- 1. For a Read operation, the r/w bit should be set to 1.
- 2. The 2nd and 3rd bits are reserved and should be set to 0.
- 3. The  $\overline{R}$  bit should always be set HIGH for a normal Read Operation.
- 4. Data Out at the slave SDO will appear after holding the slave SDI line HIGH for 32 cycles.
- 5. The 16-bit data is now available on the slave SDO line.

Detailed timing diagrams for Write and Read can be seen in Figure 4-8 and Figure 4-9.



$ \sup_{\substack{3 \ge 1 \\ 4 \ge 1 \\ 5 \ge 0}} - \left( \sup_{\alpha} \otimes \left( \otimes \left( \otimes \left( \infty \right) \left( \infty \right) \left( \infty \right) \left( \otimes \left( \otimes \left( \otimes \left( \otimes \right) \left( \otimes \right) \left( \otimes \left( \otimes \left( \otimes \right) \left( \otimes \left( $		$\mathbb{E} \left[ \left( \mathbb{E} \left( \mathbb$	₹ \aa\as \az \az \az \az \az \az	a (a (a	(D15 (D14 (D13 (D12	$\rightarrow \left  \downarrow^{t_{2}} \right _{\mathbb{R}^{2}} \left  \downarrow^{t_{2}} \right _{\mathbb{R}^{2}} \left  \langle \omega \rangle \langle \omega \rangle$
Figure 4-8: SPI Write Timing						
scv + (* ) Scv +						
$\begin{array}{c} \text{SD} & \\ \text{SD} & \\$			\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	1 A0 C6 C5 C4	(a) (a) (a)	(××) < ) < ) < ) < ) < ) < ) < ) < ) < )
Figure 4-9: SPI Read Timing						
Table 4-10: GSPI Time Delay						
Parameter	Symbol	Conditions	Min	Typ	Мах	Units
<u>CS</u> _n LOW before HOST_CLK rising edge	to	50% levels	1.5	1	1	us
HOST_CLK period	t1		100	I	I	SU
HOST_CLK duty cycle	t <sub>2</sub>		40	50	60	
Input data setup time	t <sub>3</sub>		1.5	I	I	us
Output hold time (15pF load)	t <sub>6</sub>		1.5	I	I	us
<u>CS</u> _n HIGH after last HOST_CLK rising edge	t <sub>7</sub>		75% of HOST_CLK period	I	I	SU
Input data hold time	t <sub>8</sub>		1.5	I	I.	us
GS2986 Multi-Rate SDI Reclocker with Equalization & De-emphasis Data Sheet 52134 - 3 July 2012	æ	SEM	SEMTECH			28 of 41

### 4.15.8 Daisy Chain Operation

For applications with multiple GS2986 devices, it is possible to daisy-chain up to 127 parts in serial. In this configuration, the first device SDI should be connected to the SPI Master SDO. The serial data output of each device is then connected to the serial data input of the following device, and so on. The last device's SDO connects to the Master's SDI. Connecting devices in serial reduces the number of I/O ports required by the master by removing the need for additional chip select lines.

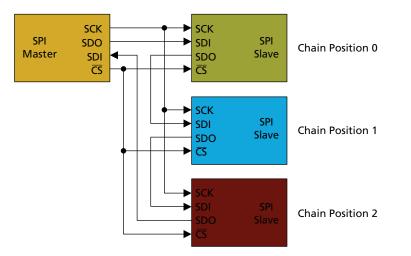


Figure 4-10: Daisy Chained SPI Bus

The position of each GS2986 device in the serial chain is referred to as its Chain Position, with 0 corresponding to the first device. The Chain Position in the SPI command word is decoded by each slave to know which device the master is talking to.

Each GS2986 slave is designed to output a replica of what it receives at its input after a delay of 32 cycles. The Chain Position part of the command is decremented by one in the duplicated command word at the output. Each device in the chain will only execute the issued command if it verifies that the current chain position is set to 0.

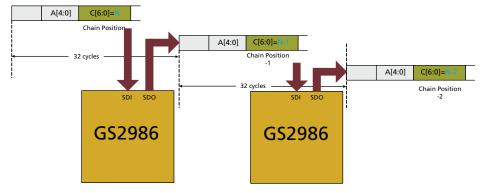


Figure 4-11: Chain Position Decoding



### 4.15.9 Read & Write Operation - Daisy Chained Devices

In a serial daisy chain configuration, Read and/or Write operations can be performed to multiple devices in the chain via consecutive operations. Figure 4-12 below shows a simple 3 device configuration.

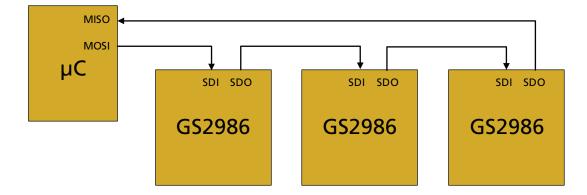
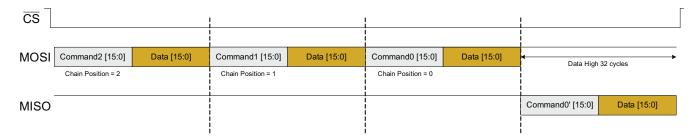


Figure 4-12: Three Devices in Daisy Chain Configuration

### 4.15.10 Writing to all Devices

When writing to all devices in the chain, a Write Command and corresponding Data is required for each device. When the devices are being configured in the same way, all of them will have the same command and data with the exception of the Chain Position bits. This example assumes a 3-device daisy chain. A command is issued to the last device in the chain first, although it is possible to talk to the devices in any order.



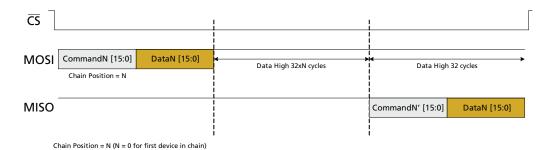
#### Figure 4-13: Daisy Chain Write

- 1. The first command issued in time is the command for the last device in the chain (chain position = 2). When the first device receives this command it will recognize that the Chain Position is 2 and will not execute the command. It will duplicate the command and data word at its output and decrement the Chain Position by one.
- 2. Consecutive commands are issued for each device in the chain as shown.



### 4.15.11 Writing to a Single Device in the Chain

The following example shows how to write to a single device in a chain:

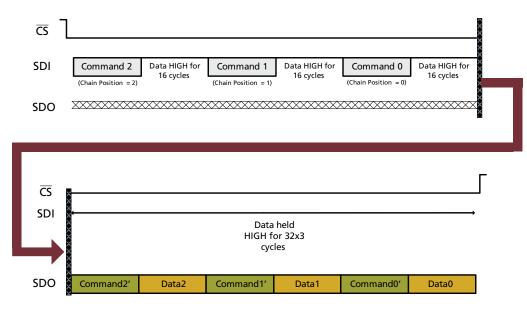


#### Figure 4-14: Daisy Chain Write to a Single Device

- 1. The command is issued to Chain Position N.
- 2. 32xN cycles are required to shift the command through N devices. The device at chain position N executes the command.
- 3. 32 additional cycles are needed to complete the communication.

### 4.15.12 Reading from all Devices

To read from all devices in the chain, a Read command is issued for each device consecutively. After each command, the data is held HIGH for 16 cycles. Once a device recognizes it is being talked to, it will output data from the register requested. Clock needs to be applied to cycle the output data through all devices in the chain.



#### Figure 4-15: Daisy Chain Read

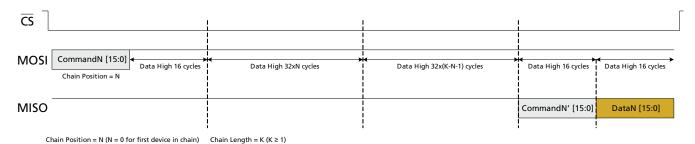
- 1. Read command is issued to the last device in the chain, followed by Read commands to the lower chain positions.
- 2. Clock is applied to cycle the output data through the chain.



3. Command2' refers to the altered or decremented Command2.

### 4.15.13 Reading from a Single Device in the Chain

The following example shows how to read from a single device in a chain:



## Figure 4-16: Daisy Chain Read from a Single Device

## 1. Read command and 16 cycles of data held HIGH are issued to chain position N.

- 2. 32xN cycles are applied with data HIGH to cycle the command through N devices in the chain (NOTE: N is 0 for first device in chain). Device N executes the command.
- 3. With K representing the total number of devices in the chain, 32x(K-N-1) cycles are applied to bring the return data through the rest of the chain.
- 4. 16 additional cycles are applied until the Data from device N is available on the Master SDI.



## 4.15.14 Host Register Map

#### Table 4-11: Host Register Map

Register Name	Register Address	Bit Position	Access	Function	Default Value	Valid Range	Comments		
EQ_1	0x00	15:10	RW	Reserved.					
		9	RW	Input Attenuation Enable (ATTEN_EN)	0x0	0 or 1	Enable for input signals above 1Vpp differential		
		8	RW	Equalizer Offset Correction Enable	0x1	0 or 1	Recommend always on		
		7	RW	Equalizer Gain Setting for DDI3	0x0	0 or 1	See supplementary table below		
		6	RW	Equalizer Gain Setting for DDI2	0x0	0 or 1	See supplementary table below		
				5	RW	Equalizer Gain Setting for DDI1	0x00	0 or 1	See supplementary table below
					4	RW	Equalizer Gain Setting for DDI0	0x00	0 or 1
		3	RW	Equalizer Enable for DDI3	0x00	0 or 1	See supplementary table below		
		2	RW	Equalizer Enable for DDI2	0x00	0 or 1	See supplementary table below		
		1	RW	Equalizer Enable for DDI1	0x00	0 or 1	See supplementary table below		
			0	RW	Equalizer Enable for DDI0	0x00	0 or 1	See supplementary table below	
				Equalizer Decode Lo	gic				
		EQ_EN	EQ_GAIN	EQ Setting	Recor	nmended	Trace Lengths		
		0	0	LOW		0 to 10 incl	hes of FR4		
		0	1	LOW		0 to 10 incl	hes of FR4		
		1	0	MED		10 to 20 inc	hes of FR4		
		1	1	HIGH	20	) or more ir	nches of FR4		



Register Name	Register Address	Bit Position	Access	Function	Default Value	Valid Range	Comments
DRIVER_1	0x01	15:10	RW	Unused	0x0	0 or 1	-
		9	RW	Amplitude Control for DDO1	0x1	0 or 1	0 = 800mV swing 1 = 400mV swing
		8	RW	Amplitude Control for DDO0	0x1	0 or 1	0 = 800mV swing 1 = 400mV swing
		7:5	RW	De-Emphasis Boost Amplitude Control for DDO1	0x2	0x0 to 0x7	0x0 = Lowest Setting 0x7 = Highest Setting
		4:2	RW	De-Emphasis Boost Amplitude Control for DDO0	0x2	0x0 to 0x7	0x0 = Lowest Setting 0x7 = Highest Setting
		1	RW	De-Emphasis Enable for DDO1	0x0	0 or 1	1 = Enabled 0 = Disabled
		0	RW	De-Emphasis Enable for DDO0	0x0	0 or 1	1 = Enabled 0 = Disabled
TOP_1	0x02	15:9	RW	Reserved.			
		8:7	RW	LOS Threshold Adjust	0x0	0x0 to 0x3	0x0 = least sensitive 0x3 = most sensitive
		6:5	RW	LOS Detection Method Select	0x0	0x0 to 0x2	0x0 = legacy edge detectionmethod 0x1 = new signal strength detectionmethod 0x2 = dual detection method: both must say signal present for LOS to be LOW
		4	RW	LOS Mute Enable	0x0	0 or 1	When enabled the output will automatically mute if Loss of Signal is HIGH
		3	RW	Power Down	0x0	0 or 1	Chip powers down when asserted
		2	RW	Tri-State Enable for SPI Output	0x0	0 or 1	When enabled the SPI SDO will be high Z when CS is not selected

### Table 4-11: Host Register Map (Continued)

Register Name	Register Address	Bit Position	Access	Function	Default Value	Valid Range	Comments
TOP_1	0x02	1	RW	Crystal Buffer Disable	0x0	0 or 1	0 = Enabled 1 = Disabled
		0	RW	Data Polarity Invert	0x0	0 or 1	0 = Not Inverted 1 = Inverted
0X03 to	o 0X0B	Reserved.					
PIN_OR_1	0x0C	15:13	RW	Unused	0x0	0 or 1	_
		12	RW	DATA/CLOCK	0x0	0 or 1	_
		11	RW	DDO1_DIASBLE	0x0	0 or 1	_
		10	RW	DATA_MUTE	0x0	0 or 1	-
		9:8	RW	КВВ	0x0	0x0, 0x2 or 0x3	Equivalent settings: 0x0 = KBB to ground 0x2 = KBB floating 0x3 = KBB to VCC
		7	RW	SS1	0x0	0 or 1	_
		6	RW	SS0	0x0	0 or 1	_
		5	RW	AUTO/MAN	0x0	0 or 1	_
		4	RW	AUTOBYPASS	0x0	0 or 1	_
		3	RW	BYPASS	0x0	0 or 1	-
		2	RW	DDI_SEL1	0x0	0 or 1	-
		1	RW	DDI_SEL0	0x0	0 or 1	-
		0	RW	Pin Override Enable	0x0	0 or 1	When enabled input values will be taken from this register instead or package pins
STATUS_1	0X0D	15:4	RO	Reserved.	_	_	_
		3	RO	SD/HD	-	_	-
		2	RO	LOCKED	-	_	-
		1	RO	SS1	_	_	_
		0	RO	SSO	_	_	_
0X0E to	o 0X11	Reserved.					

### Table 4-11: Host Register Map (Continued)



### 4.16 Device Power-up

In host mode (HIF pin tied LOW), control  $\mathcal{E}$  status registers (CSRs) may start up in a random state. There is a bit in the command word  $\overline{R}$  which will reset the CSR when set LOW.

In non-host mode (HIF pin tied HIGH), the HIF pin is used to trigger an internal reset signal to place all registers in a deterministic, default state upon power-up.

In either host mode or non-host mode, other internal state machines (e.g. offset correction and PLL) automatically recover from any state at start-up with no reset required. It takes ~10 $\mu$ s for the device to lock after start-up.

### 4.17 Standby

The purpose of Standby mode is to allow operating power to be reduced when the device's functionality is not required, and to have a rapid and simple transition to full operation when the device is required.

In order to achieve this, the device can be powered-down by writing a '1' to the 'Power Down' bit located in register address 0x02.



# **5. Typical Application Circuit**

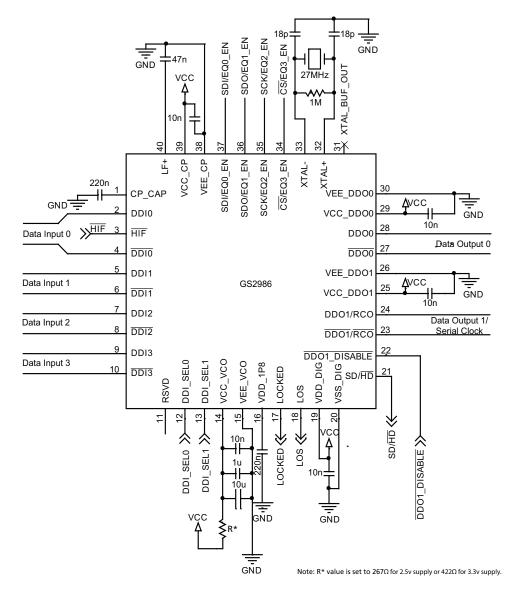
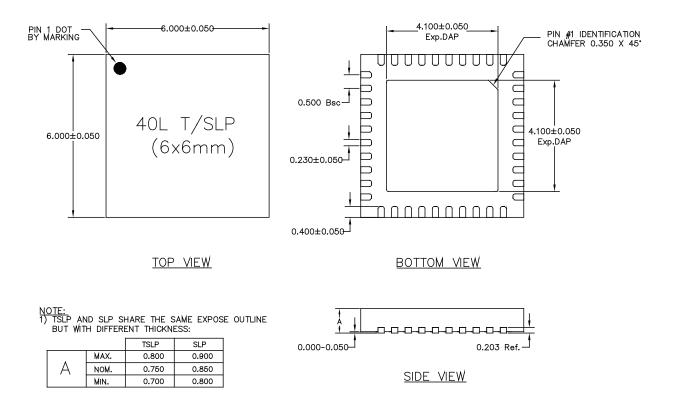


Figure 5-1: GS2986 Typical Application Circuit



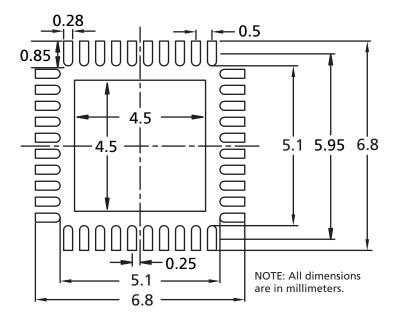
# 6. Package and Ordering Information

## **6.1 Package Dimensions**





## **6.2 Recommended PCB Footprint**



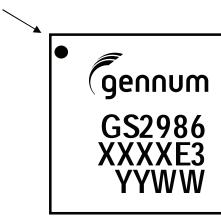
## 6.3 Packaging Data

Parameter	Value
Package Type	6mm x 6mm 40-pin QFN
Moisture Sensitivity Level	3
Junction to Case Thermal Resistance, $\theta_{j\text{-}c}$	19.9°C/W
Junction to Air Thermal Resistance, $\theta_{j\text{-}a}$ (at zero airflow)	34.9°C/W
Junction to Board Thermal Resistance, $\theta_{j-b}$	12.5°C/W
Psi, ψ	0.5°C/W
Pb-free and RoHS Compliant	Yes



## 6.4 Marking Diagram





XXXX - Last 4 digits (excluding decimal) of SAP Batch Assembly (FIN) as listed on Packing Slip. E3 - Pb-free & Green indicator YYWW - Date Code

## **6.5 Solder Reflow Profile**

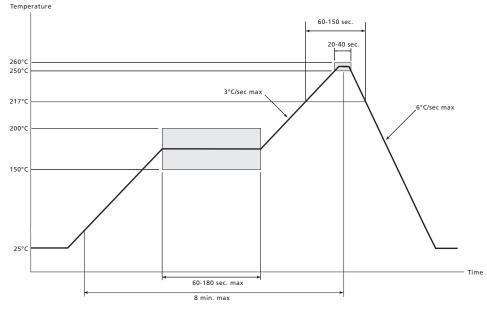


Figure 6-1: Maximum Pb-free Solder Reflow Profile

## **6.6 Ordering Information**

	Part Number	Package	Temperature Range
GS2986	GS2986-INE3	Pb-free 40-pin QFN	-40°C to 85°C
GS2986	GS2986-INTE3	Pb-free 40-pin QFN (250pc. tape and reel)	-40°C to 85°C
GS2986	GS2986-INTE3Z	Pb-free 40-pin QFN (2.5k tape and reel)	-40°C to 85°C





## DOCUMENT IDENTIFICATION DATA SHEET

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**Contact Information** 

Semtech Corporation Gennum Products Division 200 Flynn Road, Camarillo, CA 93012 Phone: (805) 498-2111, Fax: (805) 498-3804 www.semtech.com



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#### Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург, Промышленная ул, дом № 19, литера Н, помещение 100-Н Офис 331